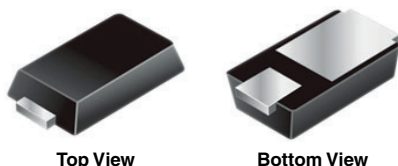


# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

## eSMP® Series



Top View

Bottom View

### MicroSMP (DO-219AD)

Anode  Cathode

**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## FEATURES

- Very low profile - typical height of 0.65 mm
- Trench MOS Schottky technology
- Low forward voltage drop
- Low power loss, high efficiency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

## TYPICAL APPLICATIONS

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications, in commercial, industrial, and automotive applications.

## LINKS TO ADDITIONAL RESOURCES



3D Models

## PRIMARY CHARACTERISTICS

$I_{F(AV)}$	1.0 A
$V_{RRM}$	200 V
$I_{FSM}$	25 A
$V_F$ at $I_F = 1.0$ A (125 °C)	0.65 V
$T_J$ max.	175 °C
Package	MicroSMP (DO-219AD)
Circuit configuration	Single

## MECHANICAL DATA

**Case:** MicroSMP (DO-219AD)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, and RoHS-compliant

Base P/NHM3\_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("\_X" denotes revision code e.g. A, B,.....)

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** color band denotes the cathode end

## MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)

PARAMETER	SYMBOL	V1P22	UNIT
Device marking code		V1D	
Maximum repetitive peak reverse voltage	$V_{RRM}$	200	V
Maximum DC reverse voltage	$V_{DC}$	160	V
Maximum average forward rectified current	$I_{F(AV)}$ <sup>(1)</sup>	1.0	A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	$I_{FSM}$	25	A
Operating junction temperature range	$T_J$ <sup>(2)</sup>	-40 to +175	°C
Storage temperature range	$T_{STG}$	-55 to +175	°C

### Notes

(1) Free air mounted on recommended copper pad area

(2) The heat generated must be less than the thermal conductivity from junction to ambient:  $dP_D/dT_J < 1/R_{\theta JA}$



ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 0.5 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.74	-	V
	I <sub>F</sub> = 1.0 A			0.80	0.88	
	I <sub>F</sub> = 0.5 A	T <sub>A</sub> = 125 °C		0.58	-	
	I <sub>F</sub> = 1.0 A			0.65	0.73	
Reverse current	V <sub>R</sub> = 160 V	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	0.001	-	mA
		T <sub>A</sub> = 125 °C		0.1	-	
	V <sub>R</sub> = 200 V	T <sub>A</sub> = 25 °C		-	0.015	
		T <sub>A</sub> = 125 °C		0.2	1.0	
Typical junction capacitance	4.0 V, 1 MHz		C <sub>J</sub>	50.0	-	pF

**Notes**

- (1) Pulse test: 300  $\mu\text{s}$  pulse width, 1 % duty cycle  
 (2) Pulse test: pulse width  $\leq 5\text{ ms}$

THERMAL CHARACTERISTICS ( $T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)			
PARAMETER	SYMBOL	V1P22	UNIT
Typical thermal resistance	$R_{\theta JA}^{(1)(2)}$	130	$^{\circ}\text{C/W}$
	$R_{\theta JM}^{(3)}$	20	

**Notes**

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$   
 (2) Free air, mounted on recommended copper pad area; thermal resistance,  $R_{\theta JA}$  - junction to ambient  
 (3) Mounted on recommended copper pad area; thermal resistance,  $R_{\theta JM}$  - junction to mount

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V1P22-M3/H	0.006	H	4500	7" diameter plastic tape and reel
V1P22HM3_A/H <sup>(1)</sup>	0.006	H	4500	7" diameter plastic tape and reel

**Note**

- (1) AEC-Q101 qualified

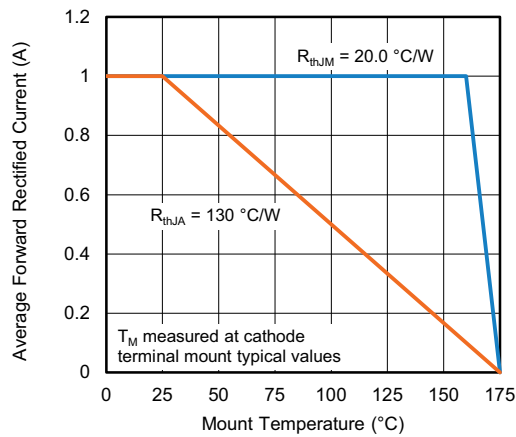
**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)


Fig. 1 - Maximum Forward Current Derating Curve

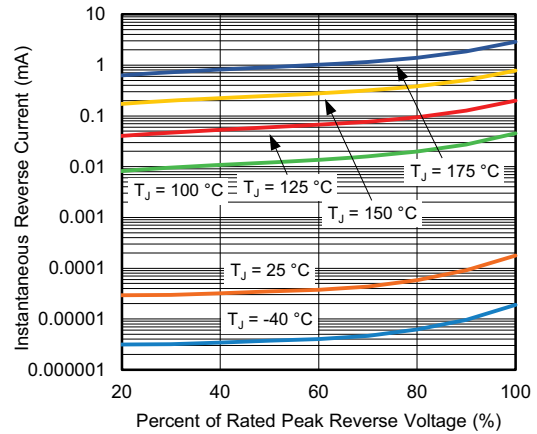


Fig. 4 - Typical Reverse Leakage Characteristics

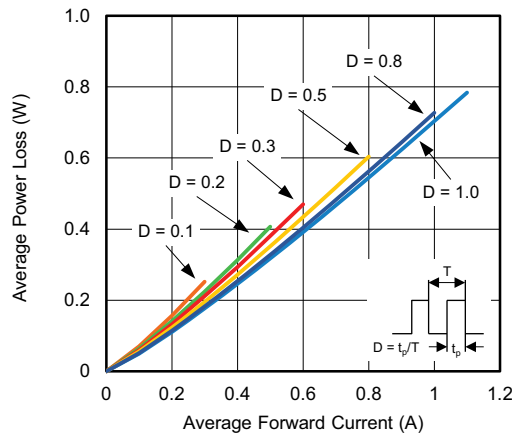


Fig. 2 - Average Power Loss Characteristics

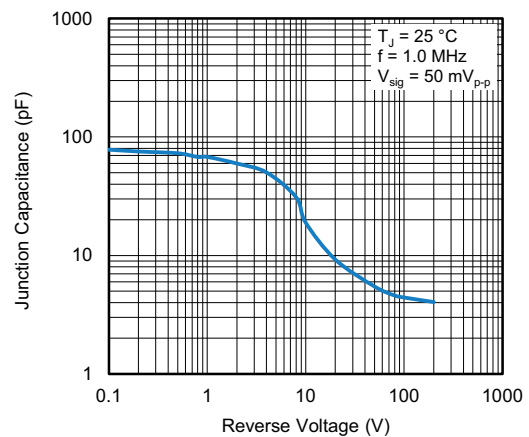


Fig. 5 - Typical Junction Capacitance

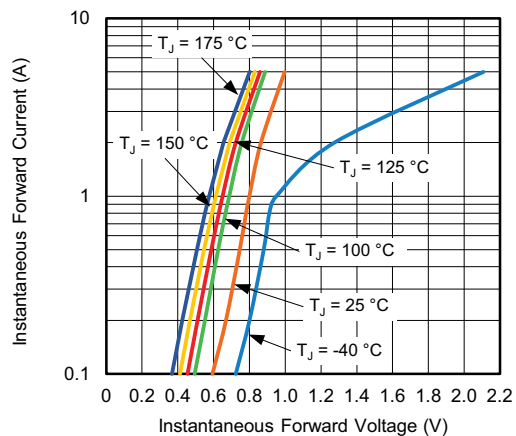


Fig. 3 - Typical Instantaneous Forward Characteristics

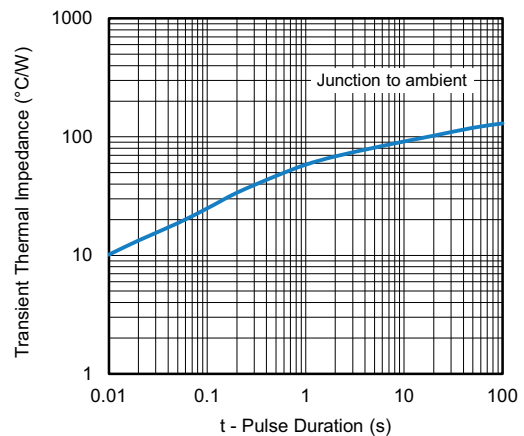
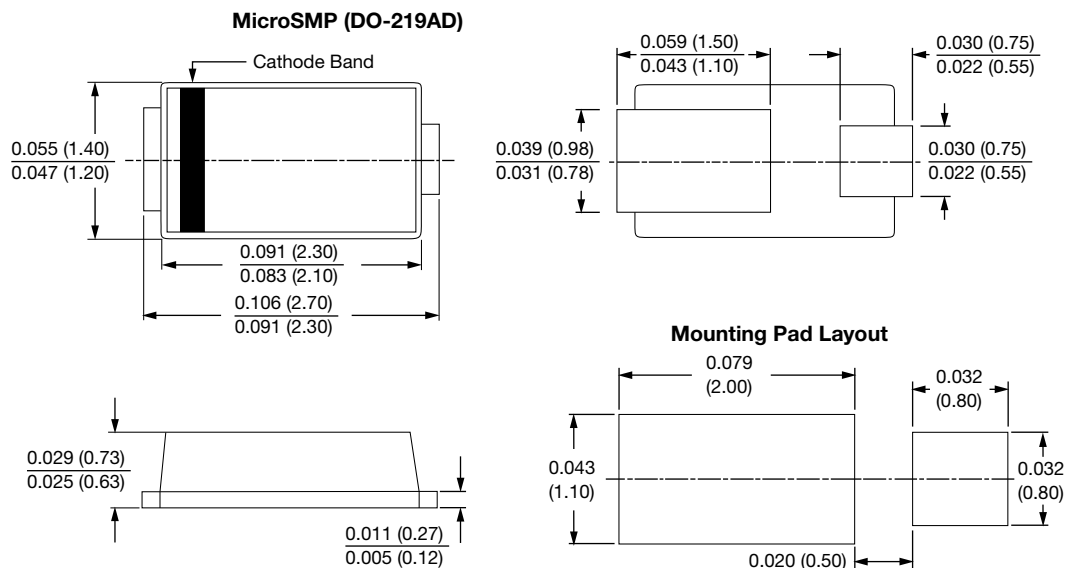


Fig. 6 - Typical Transient Thermal Impedance



**PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)





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